Crystal oscillator: SG2016/3225/5032/7050CAN & SG-210STF

Features

Crystal oscillator (SPXO)

1.2 MHz to 75 MHz Frequency:

(20 standard frequencies)

CMOS Output:

Supply voltage: 1.6 V to 3.63 V Operating temperature: -20 °C to +70 °C

-40 °C to +85 °C -40 °C to +105 °C

Applications

- IoT, Wearable device
- Data center, Storage
- Medical, Industrial automation



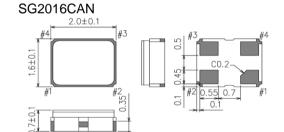
Description

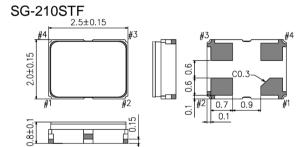
Epson's SGxxxxCAN & SG-210STF are Simple Packaged Crystal Oscillator (SPXO) series with CMOS output. These SPXO's are ideal for variety of applications from IoT, wearables, medical, industrial automation, etc.

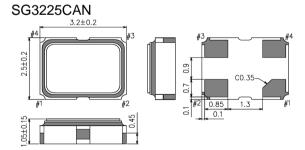
These SPXO have low current consumption, wide operating voltage from 1.6 V to 3.63 V and wide operating temperature range from -40 °C to 85 °C, in addition operation up to 105 °C is available.

These SPXO's are available in five different package size from 2.0 × 1.6 mm to 7.0 × 5.0 mm and available in standard pin out's.

Outline Drawing and Terminal Assignment

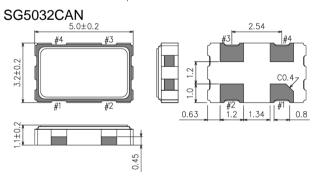


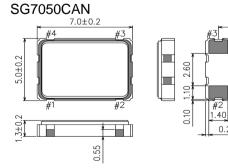




5.08

C0.5





Pin#	Connection		Function				
		ST terminal					
44	≅T	ST function	Osc. Circuit	Output			
#1	51	"H" or OPEN	Oscillation	Specified frequency: Enable			
		"L"	Oscillation stop	High impedance: Disable			
#2	GND	GND terminal					
#3	OUT	Output terminal					
#4	V _{CC}	V _{CC} terminal					

[1] Product Name / Product Number

(1-1) SG2016CAN

(1) Product Name (Standard Form)

a: Model b: Output (C:CMOS) c: Frequency d: Supply voltage

e: Frequency tolerance f: Operating temperature g: Internal identification code ("A" is default)

d: Supply voltage Refer to Figure 1						
T 1.8 V to 3.3 V Typ.						
	K	2.5 V to 3.3 V Typ.				

*Figure	1	is	on	the	next	page
94.0	•		\sim .		110/11	Pugu

e: Fr	e: Frequency tolerance / f: Operating temperature						
DB	±25 × 10 ⁻⁶ / -20 °C to +70 °C						
DG	±25 × 10 ⁻⁶ / -40 °C to +85 °C						
JG	$\pm 50 \times 10^{-6}$ / -40 °C to +85 °C						
JH	±50 × 10 ⁻⁶ / -40 °C to +105 °C						

(2) Product Number / Ordering Code

	Frequency tolerance / Operating temperature						
Frequency	DB	DG	JG	JH			
[MHz]	±25 × 10 ⁻⁶	±25 × 10 ⁻⁶	±50 × 10 ⁻⁶	±50 × 10 ⁻⁶			
	-20 °C to +70 °C	-40 °C to +85 °C	-40 °C to +85 °C	-40 °C to +105 °C			
4	-	X1G004801008300	X1G004801003000	X1G004801004900			
8	-	X1G004801008400	X1G004801004500	X1G004801004600			
10	-	X1G004801008500	X1G004801002900	X1G004801002700			
12	X1G004801005000	X1G004801009600	X1G004801000700	X1G004801005100			
12.288	X1G004801005200	X1G004801008600	X1G004801004400	X1G004801005300			
14.7456	-	X1G004801008700	X1G004801005400	X1G004801005500			
16	-	X1G004801008800	X1G004801001400	X1G004801005600			
20	X1G004801005700	X1G004801008900	X1G004801005800	X1G004801001800			
24	X1G004801005900	X1G004801007900	X1G004801000200	X1G004801004000			
24.576	-	X1G004801009000	X1G004801006000	X1G004801003100			
25	X1G004801002400	X1G004801008200	X1G004801001200	X1G004801003500			
26	-	X1G004801009100	X1G004801000300	X1G004801003900			
27	-	X1G004801008000	X1G004801006100	X1G004801002100			
32	-	X1G004801009200	X1G004801006200	X1G004801006300			
33.33	-	-	X1G004801006400	X1G004801006500			
33.3333	-	-	X1G004801002600	X1G004801006600			
40	-	X1G004801009300	X1G004801006700	X1G004801003600			
48	X1G004801006800	X1G004801009400	X1G004801002000	X1G004801006900			
50	X1G004801007000	X1G004801009500	X1G004801001300	X1G004801002800			
72	X1G004801007100	-	X1G004801007200	X1G004801007300			

Page 2 / 34 Spec No : SGxxxxCAN_E_Ver3.0

(1-2) SG-210STF

(1) Product Name (Standard Form)

a: Model b: Function (S:Standby) c: Supply voltage

d: Frequency e: Frequency tolerance / Operating temperature

c: Supply voltage Refer to Figure 1
T 1.8 V to 3.3 V Typ.

*Figure 1	is	on	the	next	page
-----------	----	----	-----	------	------

	e: Frequency tolerance / Operating temperature							
S	±25 × 10 ⁻⁶ / -20 °C to +70 °C							
J	±25 × 10 ⁻⁶ / -40 °C to +85 °C							
L	$\pm 50 \times 10^{-6}$ / -40 °C to +85 °C							
Υ	$\pm 50 \times 10^{-6}$ / -40 °C to +105 °C							

(2) Product Number / Ordering Code

	Frequency tolerance / Operating temperature						
Frequency	S	J	L	Y			
[MHz]	±25 × 10 ⁻⁶	±25 × 10 ⁻⁶	±50 × 10 ⁻⁶	±50 × 10 ⁻⁶			
	-20 °C to +70 °C	-40 °C to +85 °C	-40 °C to +85 °C	-40 °C to +105 °C			
4	-	X1G004171039800	X1G004171000900	X1G004171029900			
8	-	X1G004171039900	X1G004171001500	X1G004171006900			
10	-	X1G004171040000	X1G004171001600	X1G004171036500			
12	X1G004171016300	X1G004171041400	X1G004171001800	X1G004171028000			
12.288	X1G004171006100	X1G004171040100	X1G004171001900	X1G004171036600			
14.7456	-	X1G004171040200	X1G004171002500	X1G004171036700			
16	-	X1G004171040300	X1G004171002700	X1G004171015400			
20	X1G004171021800	X1G004171040400	X1G004171002900	X1G004171023800			
24	X1G004171015600	X1G004171040500	X1G004171003100	X1G004171019700			
24.576	-	X1G004171040600	X1G004171003200	X1G004171036800			
25	X1G004171007700	X1G004171040700	X1G004171003300	X1G004171005900			
26	-	X1G004171040800	X1G004171003400	X1G004171024400			
27	-	X1G004171040900	X1G004171003500	X1G004171025000			
32	-	X1G004171041000	X1G004171004000	X1G004171012700			
33.33	-	-	X1G004171011900	X1G004171030000			
33.3333	-	-	X1G004171012000	X1G004171007500			
40	-	X1G004171041100	X1G004171004500	X1G004171020600			
48	X1G004171007800	X1G004171041200	X1G004171004600	X1G004171036900			
50	X1G004171007900	X1G004171041300	X1G004171004700	X1G004171012600			
72	X1G004171037000	-	X1G004171012400	X1G004171037100			

Page 3 / 34 Spec No : SGxxxxCAN_E_Ver3.0

(1-3) SG3225CAN

(1) Product Name (Standard Form)

a: Model b: Output (C:CMOS) c: Frequency d: Supply voltage

e: Frequency tolerance f: Operating temperature g: Internal identification code ("A" is default)

d: Supply voltage Refer to Figure 1						
	Н	1.8 V to 3.3 V Typ.				
	K	2.5 V to 3.3 V Typ.				

*Figure	1	is	on	the	next	page
94.0	•		\sim .		110/11	Pugu

e: Fr	e: Frequency tolerance / f: Operating temperature						
DB	±25 × 10 ⁻⁶ / -20 °C to +70 °C						
DG	±25 × 10 ⁻⁶ / -40 °C to +85 °C						
JG	±50 × 10 ⁻⁶ / -40 °C to +85 °C						
JH	±50 × 10 ⁻⁶ / -40 °C to +105 °C						

(2) Product Number / Ordering Code

	Frequency tolerance / Operating temperature						
Frequency	DB	DG	JG	JH			
[MHz]	±25 × 10 ⁻⁶	±25 × 10 ⁻⁶	±50 × 10 ⁻⁶	±50 × 10 ⁻⁶			
	-20 °C to +70 °C	-40 °C to +85 °C	-40 °C to +85 °C	-40 °C to +105 °C			
4	-	X1G005961005815	X1G005961001115	X1G005961001215			
8	-	X1G005961005915	X1G005961000415	X1G005961001315			
10	-	X1G005961006015	X1G005961000515	X1G005961001415			
12	X1G005961001515	X1G005961006715	X1G005961000615	X1G005961001615			
12.288	X1G005961001715	X1G005961006115	X1G005961001815	X1G005961001915			
14.7456	-	X1G005961006215	X1G005961002015	X1G005961002115			
16	-	X1G005961005115	X1G005961002215	X1G005961002315			
20	X1G005961002415	X1G005961006315	X1G005961000715	X1G005961002515			
24	X1G005961002615	X1G005961005215	X1G005961000115	X1G005961002715			
24.576	-	X1G005961006415	X1G005961000815	X1G005961002815			
25	X1G005961002915	X1G005961005315	X1G005961000215	X1G005961003015			
26	-	X1G005961006515	X1G005961003115	X1G005961003215			
27	-	X1G005961005415	X1G005961003315	X1G005961003415			
32	-	X1G005961006615	X1G005961003515	X1G005961003615			
33.33	-	•	X1G005961003715	X1G005961003815			
33.3333	-	•	X1G005961003915	X1G005961004015			
40	-	X1G005961005515	X1G005961000915	X1G005961004115			
48	X1G005961004215	X1G005961005615	X1G005961000315	X1G005961004315			
50	X1G005961004415	X1G005961005715	X1G005961001015	X1G005961004515			
72	X1G005961004615	-	X1G005961004715	X1G005961004815			

Page 4 / 34 Spec No : SGxxxxCAN_E_Ver3.0

(1-4) SG5032CAN

(1) Product Name (Standard Form)

a: Model b: Output (C:CMOS) c: Frequency d: Supply voltage

e: Frequency tolerance f: Operating temperature g: Internal identification code ("A" is default)

d: Supply voltage Refer to Figure 1							
	Η	1.8 V to 3.3 V Typ.					
	K	2.5 V to 3.3 V Typ.					

*Figure	1	is	on	the	next	page
94.0	•		\sim .		110/11	Pugu

e: Fr	e: Frequency tolerance / f: Operating temperature							
DB	±25 × 10 ⁻⁶ / -20 °C to +70 °C							
DG	±25 × 10 ⁻⁶ / -40 °C to +85 °C							
JG	$\pm 50 \times 10^{-6}$ / -40 °C to +85 °C							
JH	±50 × 10 ⁻⁶ / -40 °C to +105 °C							

(2) Product Number / Ordering Code

	Frequency tolerance / Operating temperature								
Frequency	DB	DG	JG	JH					
[MHz]	±25 × 10 ⁻⁶	±25 × 10 ⁻⁶	±50 × 10 ⁻⁶	±50 × 10 ⁻⁶					
	-20 °C to +70 °C	-40 °C to +85 °C	-40 °C to +85 °C	-40 °C to +105 °C					
4	-	X1G004451022100	X1G004451003400	X1G004451019600					
8	-	X1G004451022200	X1G004451002100	X1G004451019700					
10	-	X1G004451022300	X1G004451001300	X1G004451017800					
12	X1G004451019800	X1G004451023700	X1G004451002800	X1G004451019900					
12.288	X1G004451020000	X1G004451022400	X1G004451000100	X1G004451020100					
14.7456	-	X1G004451022500	X1G004451001900	X1G004451020200					
16	-	X1G004451022600	X1G004451000200	X1G004451020300					
20	X1G004451020400	X1G004451022700	X1G004451001100	X1G004451020500					
24	X1G004451017200	X1G004451022800	X1G004451000300	X1G004451020600					
24.576	-	X1G004451022900	X1G004451002900	X1G004451020700					
25	X1G004451009700	X1G004451023000	X1G004451000400	X1G004451020800					
26	-	X1G004451023100	X1G004451008200	X1G004451020900					
27	-	X1G004451023200	X1G004451000500	X1G004451021000					
32	-	X1G004451023300	X1G004451001400	X1G004451021100					
33.33	-	•	X1G004451021200	X1G004451021300					
33.3333	-	•	X1G004451016700	X1G004451021400					
40	-	X1G004451023400	X1G004451001200	X1G004451021500					
48	X1G004451014900	X1G004451023500	X1G004451000700	X1G004451011200					
50	X1G004451011500	X1G004451023600	X1G004451000800	X1G004451003600					
72	X1G004451021600	-	X1G004451021700	X1G004451021800					

Page 5 / 34 Spec No : SGxxxxCAN_E_Ver3.0

(1-5) SG7050CAN

(1) Product Name (Standard Form)

a: Model b: Output (C:CMOS) c: Frequency d: Supply voltage

e: Frequency tolerance f: Operating temperature g: Internal identification code ("A" is default)

d: Supply voltage Refer to Figure 1							
T 1.8 V to 3.3 V Typ. K 2.5 V to 3.3 V Typ.							

*Figure	1	ic	οn	the	next	nage
riguie		15	OH	uie	HEX	paye

e: Fr	e: Frequency tolerance / f: Operating temperature							
	±25 × 10 ⁻⁶ / -20 °C to +70 °C							
DG	±25 × 10 ⁻⁶ / -40 °C to +85 °C							
JG	$\pm 50 \times 10^{-6}$ / -40 °C to +85 °C							
JH	±50 × 10 ⁻⁶ / -40 °C to +105 °C							

(2) Product Number / Ordering Code

	Frequency tolerance / Operating temperature							
Frequency	DB	DG	JG	JH				
[MHz]	±25 × 10 ⁻⁶	±25 × 10 ⁻⁶	±50 × 10 ⁻⁶	±50 × 10 ⁻⁶				
	-20 °C to +70 °C	-40 °C to +85 °C	-40 °C to +85 °C	-40 °C to +105 °C				
4	-	X1G004481027400	X1G004481005100	X1G004481025200				
8	-	X1G004481027500	X1G004481001400	X1G004481025300				
10	-	X1G004481027600	X1G004481000500	X1G004481025400				
12	X1G004481025500	X1G004481029000	X1G004481000600	X1G004481025600				
12.288	X1G004481025700	X1G004481027700	X1G004481000100	X1G004481025800				
14.7456	-	X1G004481027800	X1G004481002500	X1G004481025900				
16	-	X1G004481027900	X1G004481000700	X1G004481026000				
20	X1G004481012800	X1G004481028000	X1G004481000800	X1G004481026100				
24	X1G004481002200	X1G004481028100	X1G004481000200	X1G004481026200				
24.576	-	X1G004481028200	X1G004481001600	X1G004481026300				
25	X1G004481011600	X1G004481028300	X1G004481000300	X1G004481026400				
26	-	X1G004481028400	X1G004481003500	X1G004481026500				
27	-	X1G004481028500	X1G004481000400	X1G004481026600				
32	-	X1G004481028600	X1G004481000900	X1G004481026700				
33.33	-	-	X1G004481017900	X1G004481026800				
33.3333	-	-	X1G004481003300	X1G004481026900				
40	-	X1G004481028700	X1G004481001500	X1G004481027000				
48	X1G004481022600	X1G004481028800	X1G004481001100	X1G004481027100				
50	X1G004481011200	X1G004481028900	X1G004481001200	X1G004481016000				
72	X1G004481027200	-	X1G004481018300	X1G004481027300				

Page 6 / 34 Spec No : SGxxxxCAN_E_Ver3.0

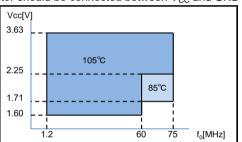
[2] Absolute Maximum Ratings

Parameter	Symbol		Specification	1	Unit	Conditions
Falallielei	Symbol	Min.	Тур.	Max.		
Maximum supply voltage	V_{CC}	-0.3	-	4	V	
Input voltage	Vin	-0.3	-	$V_{CC} + 0.3$	V	ST terminal
Storage temperature range	T_stg	-55	-	+125	°C	SG2016CAN, SG3225CAN
Storage temperature range		-40	-	+125	°C	All other

[3] Operating Range

Parameter	Symbol		Specification)	Unit	Conditions
Farameter	Symbol	Min.	Тур.	Max.	Offic	
	V _{CC}	1.6		3.63	V	1.2 MHz ≤ fo ≤ 60 MHz, T_use = +105 °C Max.
Supply voltage		1.71	ı	3.63	V	60 MHz < fo ≤ 75 MHz, T_use = +85 °C Max.
		2.25	ı	3.63	V	60 MHz < fo ≤ 75 MHz, T_use = +105 °C Max.
Supply voltage	GND	0.0	0.0	0.0	V	
Operating temperature range		-20	+25	+70	°C	
Operating temperature range (Refer to Figure 1)	T_use	-40	+25	+85	°C	
(Refer to Figure 1)		-40	+25	+105	°C	
CMOS load condition	L_CMOS	-	-	15	pF	

^{*} Power supply startup time (0 % $V_{CC} \rightarrow 90$ % V_{CC}) should be more than 150 μ s * A 0.01 μ F to a 0.1 μ F bypass capacitor should be connected between V_{CC} and GND pins located close to the device



Please note that Supply voltage range (V_{CC}) depends on Output frequency(fo) and upper limit of Operating temperature(T_use Max.).

Figure 1: The upper limit of Operating temperature and the related conditions

[4] Frequency Characteristics	stated othe	rwise [3] Operating Range)				
Parameter	Symbol		Specification	า	Unit	Conditions
Farameter	Symbol	Min.	Тур.	Max.	Offic	Conditions
	fo	1.2	-	75	×10 ⁻⁶	Please contact us for frequencies other than the standard ones.
Output frequency		4, 8, 10, 12, 12.288, 14.7456, 16, 20, 24, 24.576, 25, 26, 27, 32, 33.33, 33.3333, 40, 48, 50, 72			MHz	Standard frequency
Frequency tolerance *1	f_tol	-25	-	+25	×10 ⁻⁶	T_use = -20 °C ~ +70 °C, -40 °C ~ +85 °C
Trequency tolerance		-50	-	+50	×10 ⁻⁶	T_use = -40 °C ~ +85 °C, -40 °C ~ +105 °C
Frequency aging	f_age	-3		+3	×10 ⁻⁶	T_use = +25 °C, First year

^{*1} Frequency tolerance includes initial frequency tolerance, frequency / temperature characteristics, frequency / voltage coefficient, and frequency / load coefficient

Page 7 / 34 Spec No: SGxxxxCAN_E_Ver3.0

[5] Electrical Characteristics

(Unless stated otherwise [3] Operating Range)

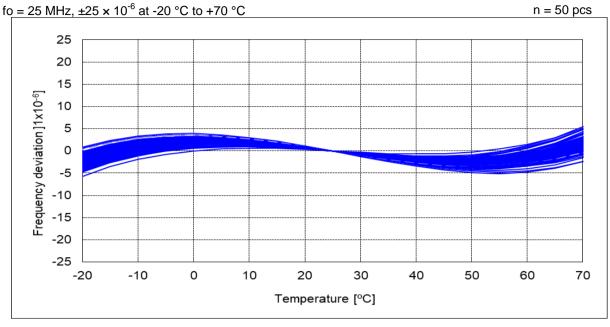
Deremeter	Cymphal		Specification		Unit	Conditions
Parameter	Symbol	Min.	Тур.	Max.		
Start-up time	t_str	-	-	3	ms	t = 0 at 90 %V _{CC}
Current consumption (No load)		-	-	1.5	mA	1.2 MHz ≤ fo ≤ 20 MHz
Current consumption (No load) $V_{CC} = 1.8 \text{ V} \pm 10 \text{ \%}$		-	-	1.8	mA	20 MHz < fo ≤ 40 MHz
V _{CC} = 1.0 V ± 10 /0		-	-	2.1	mA	40 MHz < fo ≤ 60 MHz
V _{CC} = 1.8 V ± 5 %		-	-	2.4	mA	60 MHz < fo ≤ 75 MHz
		-	-	1.6	mA	1.2 MHz ≤ fo ≤ 20 MHz
Current consumption (No load)	1	-	-	2.0	mA	20 MHz < fo ≤ 40 MHz
$V_{CC} = 2.5 \text{ V} \pm 10 \%$	I _{CC}	-	-	2.4	mA	40 MHz < fo ≤ 60 MHz
		-	-	2.8	mA	60 MHz < fo ≤ 75 MHz
		-	-	1.8	mA	1.2 MHz ≤ fo ≤ 20 MHz
Current consumption (No load)		-	-	2.2	mA	20 MHz < fo ≤ 40 MHz
$V_{CC} = 3.3 \text{ V} \pm 10 \%$		-	-	2.6	mA	40 MHz < fo ≤ 60 MHz
		-	-	3.0	mA	60 MHz < fo ≤ 75 MHz
	I_std	-	-	2.1	μΑ	$V_{CC} = 1.8 \text{ V} \pm 10 \text{ % or } \pm 5 \text{ %},$ $\overline{ST} = \text{GND}$
Stand-by current		-	-	2.5	μΑ	$V_{CC} = 2.5 \text{ V} \pm 10 \%, \overline{ST} = \text{GND}$
		-	-	2.7	μΑ	$V_{CC} = 3.3 \text{ V} \pm 10 \text{ \%}, \overline{ST} = \text{GND}$
	V_{OH}	90 % V _{CC}	-	-	V	Load current condition 1.8 V ± 10 % 2.5 V ± 10 % 3.3 V ± 10 %
Output voltage	V_{OL}	-	-	10 % V _{CC}	V	I _{OH}
Carpar voltago	V _{OH}	V _{CC} - 0.4	-	-	V	Load current condition 1.8 V ± 10 % 2.5 V ± 10 % 3.3 V ± 10 %
	V_{OL}	-	-	0.4	V	I _{OH}
Symmetry	SYM	45	50	55	%	50 % V _{CC} level, L_CMOS ≤ 15 pF
Rise time/Fall time	tr / tf	-	ı	3	ns	V_{CC} = 2.5 V or 3.3 V ± 10 %, 20 % V_{CC} to 80 % V_{CC} Level, L_CMOS = 15 pF
1430 umo/i an umo	11 / 11	-	-	3.5	ns	$V_{CC} = 1.8 \text{ V} \pm 10 \text{ % or } \pm 5 \text{ %},$ 20 % V_{CC} to 80 % V_{CC} Level, $L_CMOS = 15 \text{ pF}$
Input voltage	V_{IH}	80 % Vcc	-	-	V	ST terminal
linput voltage	V _{IL}	-	-	20 % Vcc	V	
Output disable time (ST)	tstp_st	-	-	100	ns	ST terminal HIGH → LOW
Output enable time (ST)	tsta_st	-	-	3	ms	ST terminal LOW → HIGH

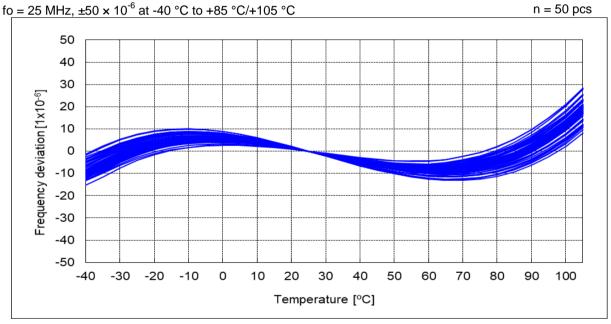
[6] Thermal resistance (For reference only)

December 1 of 16	Symbol	Specification			1.120	0 1111
Parameter		Min.	Тур.	Max.	Unit	Conditions
Junction temperature	Tj	-	-	+125	°C	
		•	9.8	-	°C/W	SG2016CAN
		1	15.2	-	°C/W	SG-210STF
Junction to case	θјс	-	23.1	-	°C/W	SG3225CAN
		-	16.1	-	°C/W	SG5032CAN
		•	28.0	-	°C/W	SG7050CAN
		1	99.6	-	°C/W	SG2016CAN
Junction to ambient	θја	-	91.9	-	°C/W	SG-210STF
		-	103.8	-	°C/W	SG3225CAN
		-	82.5	-	°C/W	SG5032CAN
		-	78.8	-	°C/W	SG7050CAN

Spec No: SGxxxxCAN_E_Ver3.0 Page 8 / 34

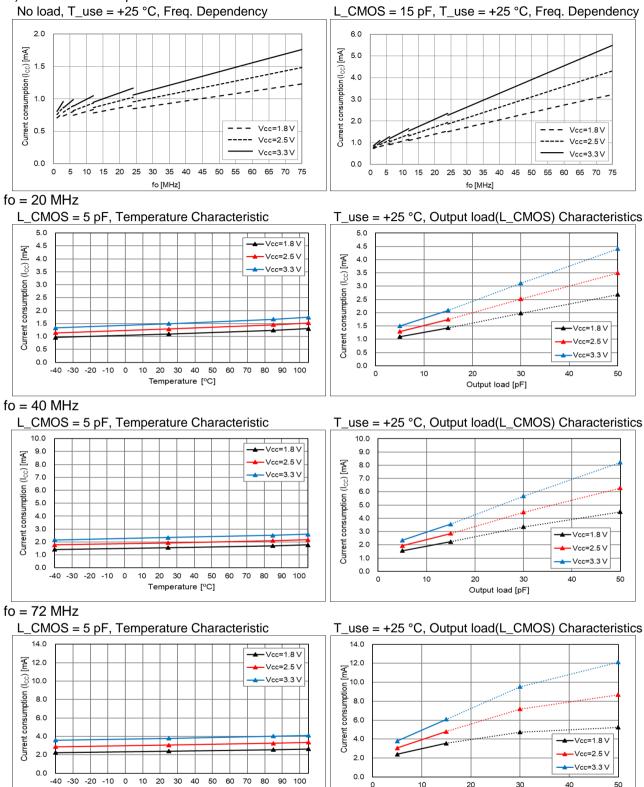
[7] Typical Performance Characteristics (For reference only)
 The following data shows typical performance characteristics
 (7-1) Frequency / Temperature Characteristics





Page 9 / 34 Spec No : SGxxxxCAN_E_Ver3.0

(7-2) Current Consumption



^{*} Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.

Temperature [°C]

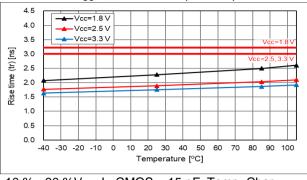
The actual current consumption is the total of the current under the condition of no load and the current to drive the output load (fo \times L_CMOS \times V_{CC}). To reduce the current consumption, it is effective to use lower frequency, lower supply voltage and lower output load.

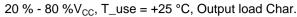
Output load [pF]

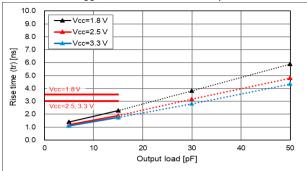
(7-3) Rise Time / Fall Time

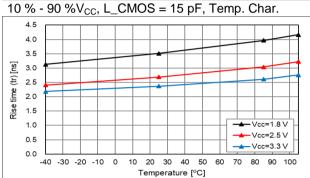
fo = 20 MHz, Rise Time

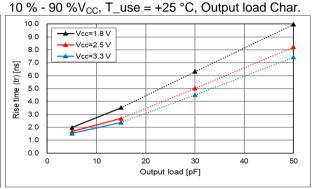
 $20 \% - 80 \%V_{CC}$, L_CMOS = 15 pF, Temp. Char.







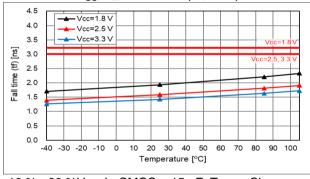


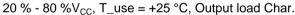


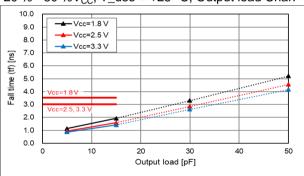
^{*} Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.

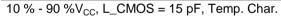
fo = 20 MHz, Fall Time

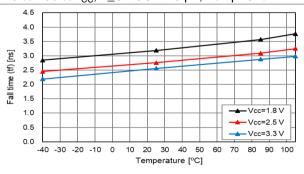
20 % - 80 %V_{CC}, L_CMOS = 15 pF, Temp. Char.

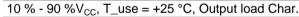


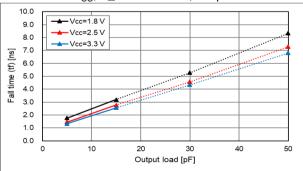












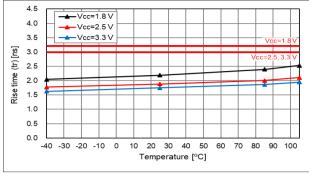
^{*} Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.

Page 11 / 34 Spec No : SGxxxxCAN_E_Ver3.0

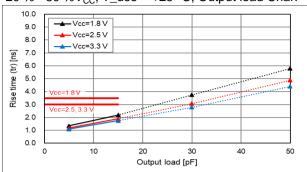
(7-3) Rise Time / Fall Time [cont'd]

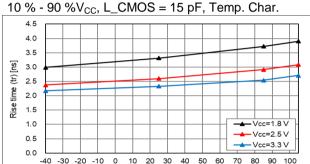
fo = 40 MHz, Rise Time

20 % - 80 %V_{CC}, L_CMOS = 15 pF, Temp. Char.

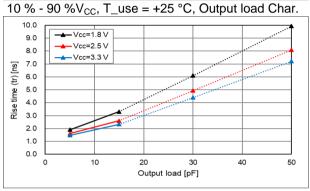


20 % - 80 % V_{CC} , $T_use = +25$ °C, Output load Char.





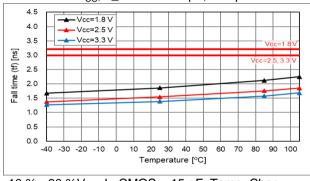
Temperature [°C]

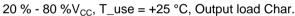


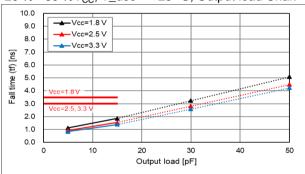
^{*} Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.

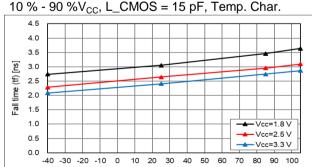
fo = 40 MHz, Fall Time

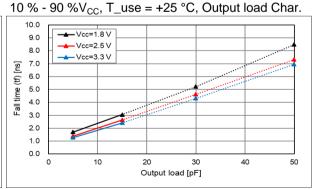
 $20 \% - 80 \%V_{CC}$, L_CMOS = 15 pF, Temp. Char.











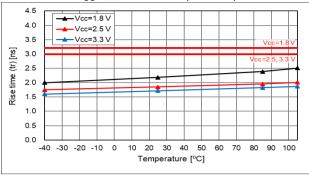
^{*} Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference.

Page 12 / 34 Spec No : SGxxxxCAN_E_Ver3.0

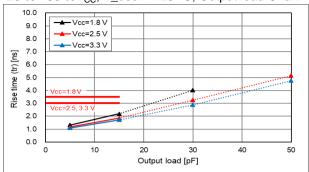
(7-3) Rise Time / Fall Time [cont'd]

fo = 72 MHz, Rise Time

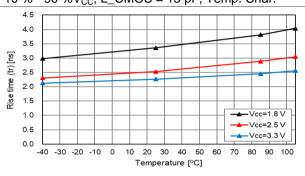
20 % - 80 %V_{CC}, L_CMOS = 15 pF, Temp. Char.



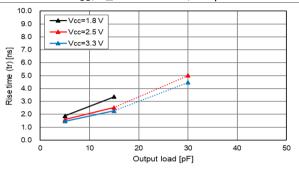
20 % - 80 %V_{CC}, T_use = +25 °C, Output load Char.







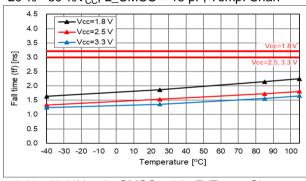
10 % - 90 % V_{CC} , $T_use = +25$ °C, Output load Char.



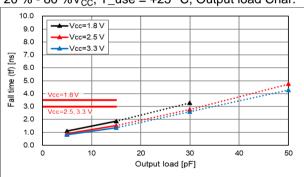
* Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference. There are some missing data in the graph. It is unmeasurable because of low amplitude under the condition of L_CMOS > 15 pF.

fo = 72 MHz, Fall Time

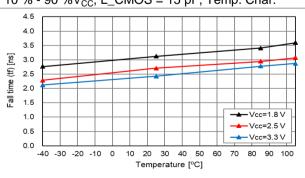
20 % - 80 %V_{CC}, L_CMOS = 15 pF, Temp. Char.



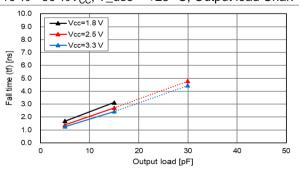
20 % - 80 %V_{CC}, T_use = +25 °C, Output load Char.







10 % - 90 %V_{CC}, T_use = +25 °C, Output load Char.



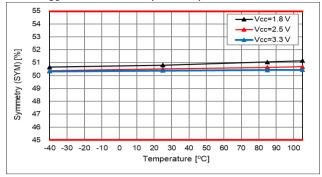
^{*} Output load condition under L_CMOS > 15 pF (dotted line area) is not guaranteed, and the data is for reference. There are some missing data in the graph. It is unmeasurable because of low amplitude under the condition of L_CMOS > 15 pF.

Page 13 / 34 Spec No : SGxxxxCAN_E_Ver3.0

(7-4) Symmetry

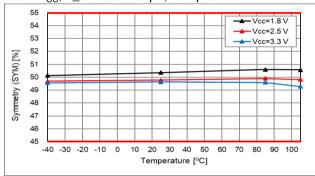
fo = 20 MHz

50 % V_{CC} , L_CMOS = 15 pF, Temp. Char.



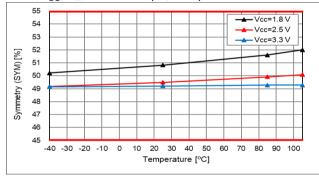
fo = 40 MHz

 50 %V_{CC} , L_CMOS = 15 pF, Temp. Char.



fo = 72 MHz

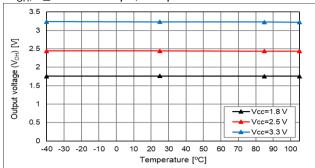
50 % V_{CC} , L_CMOS = 15 pF, Temp. Char.



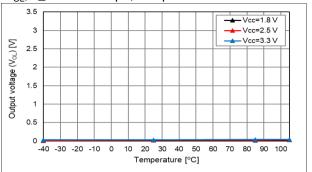
(7-5) Output Voltage

fo = 20 MHz

V_{OH}, L_CMOS = 15 pF, Temp. Char.

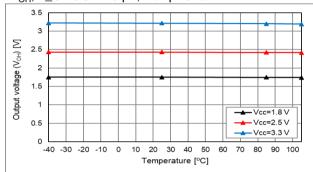


V_{OL}, L_CMOS = 15 pF, Temp. Char.

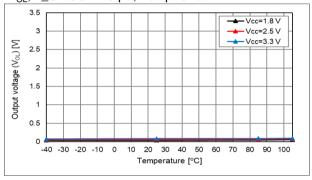


fo = 40 MHz

 V_{OH} , L_CMOS = 15 pF, Temp. Char.

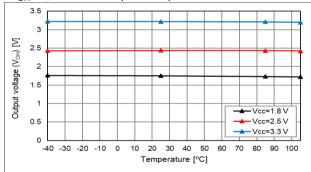


V_{OL}, L_CMOS = 15 pF, Temp. Char.

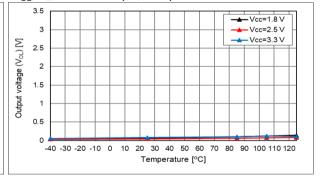


fo = 72 MHz

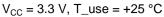
 V_{OH} , L_CMOS = 15 pF, Temp. Char.

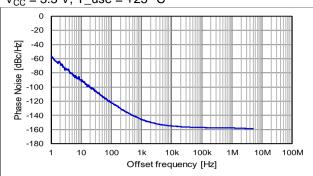


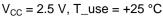
 V_{OL} , L_CMOS = 15 pF, Temp. Char.

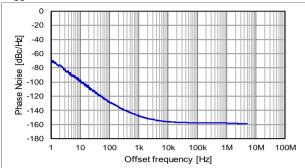


(7-6) Phase Noise, Phase Jitter, and Jitter fo = 20 MHz

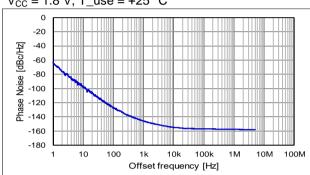








V_{CC} = 1.8 V, T_use = +25 °C



Phase Jitter (Offset frequency: 12 kHz to 5 MHz)

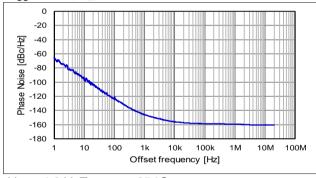
V_{CC}	Phase Jitter
3.3 V	0.31 ps
2.5 V	0.31 ps
1.8 V	0.32 ps

Jitter (T_use = +25 $^{\circ}$ C, V_{CC} = 3.3 V)

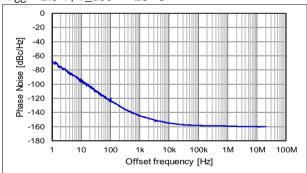
Total jitter (BER = 10 ⁻¹²)	31.3 ps
RMS jitter	1.8 ps
Peak to peak jitter	15 ps

fo = 40 MHz

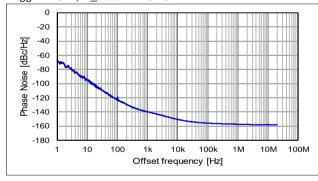
 V_{CC} = 3.3 V, T_use = +25 °C



 $V_{CC} = 2.5 \text{ V}, T_{use} = +25 \text{ °C}$



 $V_{CC} = 1.8 \text{ V}, T_{use} = +25 \text{ °C}$



Phase Jitter (Offset frequency: 12 kHz to 20 MHz)

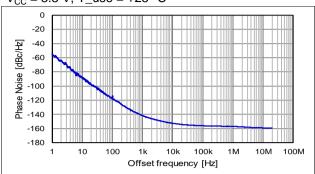
V _{CC}	Phase Jitter		
3.3 V	0.24 ps		
2.5 V	0.26 ps		
1.8 V	0.32 ps		

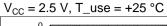
Jitter (T_use = +25 $^{\circ}$ C, V_{CC} = 3.3 V)

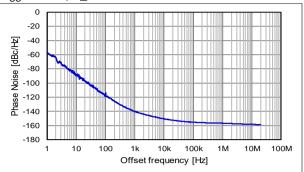
· - · · ·	,
Total jitter (BER = 10 ⁻¹²)	22.3 ps
RMS jitter	1.8 ps
Peak to peak jitter	16 ps

(7-6) Phase Noise and Phase Jitter [cont'd] fo = 72 MHz

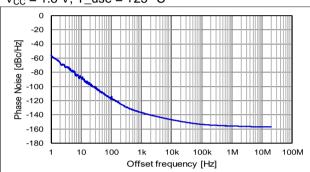
$$V_{CC} = 3.3 \text{ V}, T_use = +25 °C$$







V_{CC} = 1.8 V, T_use = +25 °C



Phase Jitter (Offset frequency: 12 kHz to 20 MHz)

V_{CC}	Phase Jitter
3.3 V	0.16 ps
2.5 V	0.17 ps
1.8 V	0.20 ps

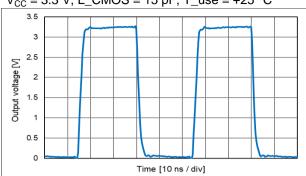
Jitter (T_use = +25 $^{\circ}$ C, V_{CC} = 3.3 V)

, _	,
Total jitter (BER = 10 ⁻¹²)	21.8 ps
RMS jitter	1.8 ps
Peak to peak jitter	16 ps

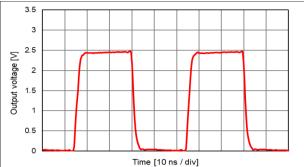
(7-7) Output Waveform

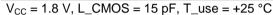
fo = 20 MHz

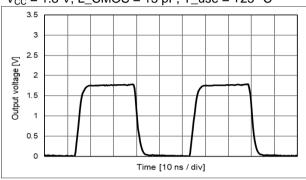
$$V_{CC}$$
 = 3.3 V, L_CMOS = 15 pF, T_use = +25 °C



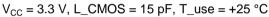


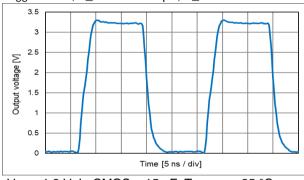




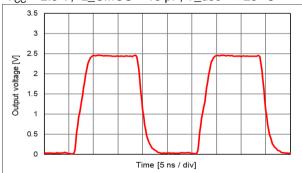


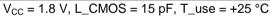
fo = 40 MHz

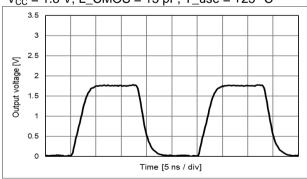




 $V_{CC} = 2.5 \text{ V}, \text{ L_CMOS} = 15 \text{ pF}, \text{T_use} = +25 ^{\circ}\text{C}$





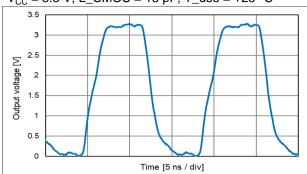


Page 18 / 34 Spec No : SGxxxxCAN_E_Ver3.0

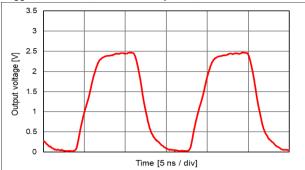
(7-7) Output Waveform [cont'd]

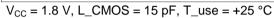
fo = 72 MHz

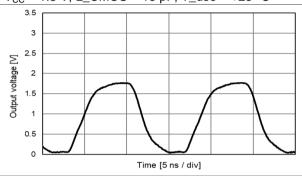
$$V_{CC}$$
 = 3.3 V, L_CMOS = 15 pF, T_use = +25 °C



 $V_{CC} = 2.5 \text{ V}, \text{ L_CMOS} = 15 \text{ pF}, \text{T_use} = +25 \text{ }^{\circ}\text{C}$



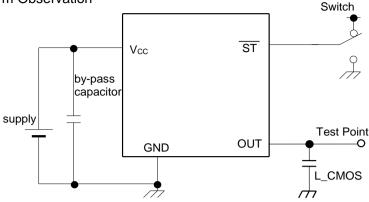




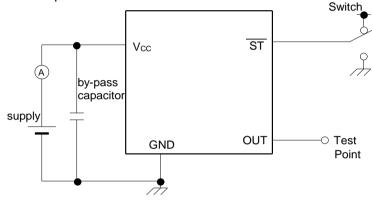
Page 19 / 34 Spec No : SGxxxxCAN_E_Ver3.0

[8] Test Circuit

(8-1) Waveform Observation



(8-2) Current Consumption Test



*Standby current test should be $\overline{ST} = GND$.

(8-3) Condition

(1) Oscilloscope

The bandwidth should be minimum 5 times wider than measurement frequency The probe ground should be placed closely to the test point and the lead length should be as short as possible

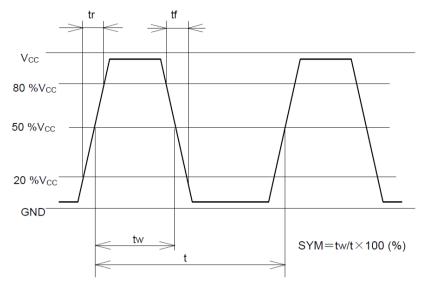
- * It is recommended to use miniature socket. (Don't use earth lead.)
- (2) L_CMOS includes probe capacitance.
- (3) A 0.01 μF to a 0.1 μF bypass capacitor should be connected between V_{CC} and GND pins located close to the device
- (4) Use a current meter with a low internal impedance
- (5) Power Supply

Power supply startup time (0 %V_{CC} \rightarrow 90 %V_{CC}) should be more than 150 µs Power supply impedance should be as low as possible

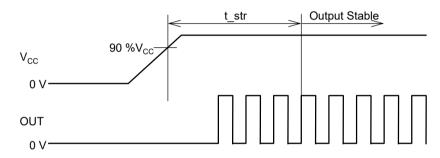
Page 20 / 34 Spec No : SGxxxxCAN_E_Ver3.0

(8-4) Timing Chart

(1) Output Waveform and Level

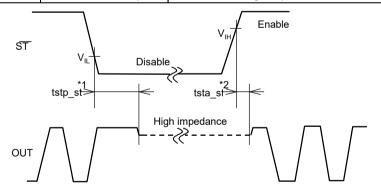


(2) Output Frequency Timing



(3) ST Function and Timing

	i anotion and in	·····9			
ST Terminal Osc. circuit		Osc. circuit	Output status		
"H" or OPEN Oscillation		Oscillation	Specified frequency: Enable		
	"L" Oscillation stop		High impedance: Disable		



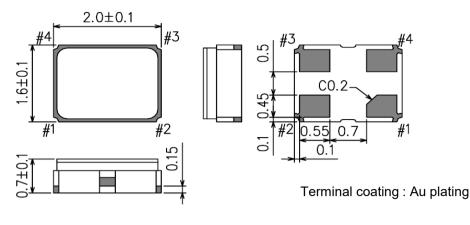
- *1 The period from $\overline{ST} = V_{IL}$ to OUT = High impedance (Disable)
- *2 The period from $\overline{ST} = V_{IH}$ to OUT = Enable
- * Judge of starting output: $V_{0H} \ge 80 \ \%V_{CC}, \ V_{0L} \le 20 \ \%V_{CC}, \ fout is within fo <math>\pm \ 1 \ 000 \ \times \ 10^{-6}$
- * ST terminal voltage level should not exceed supply voltage when using ST function.

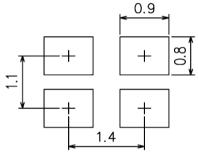
 Please note that ST rise time should not exceed supply voltage rise time at the start-up.

Page 21 / 34 Spec No : SGxxxxCAN_E_Ver3.0

[9] Outline Drawing and Recommended Footprint (9-1) SG2016CAN

Units: mm





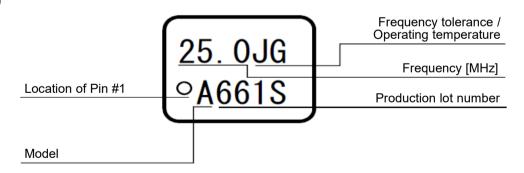
For stable operation, it is recommended that 0.01 μ F to 0.1 μ F bypass capacitors should be connected between V_{CC} and GND and placed as close to the V_{CC} pin as possible.

Reference Weight Typ.: 9.9 mg

Terminal Assignment

Trimal 7 toolgrimont						
Pin #	Connection	Function				
		ST terminal	ST terminal			
#1 <u>ST</u>	ST function	Osc. Circuit	Output			
#1	#1 ST	"H" or OPEN	Oscillation	Specified frequency: Enable		
		"L"	Oscillation stop	High impedance: Disable		
#2	GND	GND terminal				
#3	OUT	Output terminal				
#4	V_{CC}	V _{CC} terminal				

Marking



Page 22 / 34 Spec No : SGxxxxCAN_E_Ver3.0

(9-2) SG-210STF

 2.0 ± 0.15

2.5±0.15 #4

2.5±0.15

#3

#4

C0.3

#1

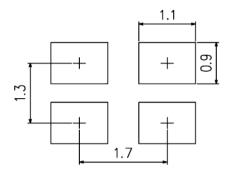
#2

0.7

0.9

#1

Terminal coating: Au plating



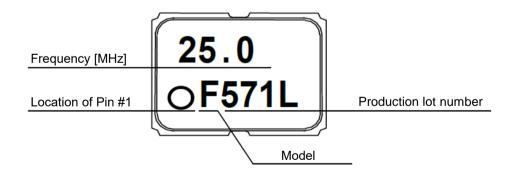
For stable operation, it is recommended that 0.01 μ F to 0.1 μ F bypass capacitors should be connected between V_{CC} and GND and placed as close to the V_{CC} pin as possible.

Reference Weight Typ.: 14 mg

Terminal Assignment

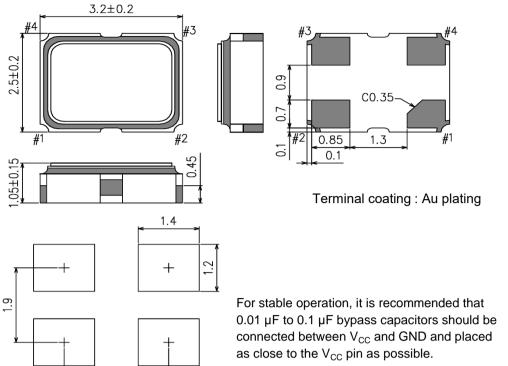
Pin #	Connection	Function				
		ST terminal	ST terminal			
	S₹	ST function	Osc. Circuit	Output		
#1	#1 ST	"H" or OPEN	Oscillation	Specified frequency: Enable		
		"L"	Oscillation stop	High impedance: Disable		
#2	GND	GND terminal				
#3	OUT	Output terminal				
#4	V _{cc}	V _{CC} terminal				

Marking



Page 23 / 34 Spec No : SGxxxxCAN_E_Ver3.0

(9-3) SG3225CAN

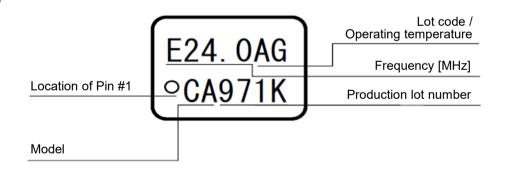


Reference Weight Typ.: 25 mg

Terminal Assignment

Trimal 7 toolgrimont						
Pin #	Connection	Function				
		ST terminal	ST terminal			
#1 <u>ST</u>	ST function	Osc. Circuit	Output			
#1	#1 ST	"H" or OPEN	Oscillation	Specified frequency: Enable		
		"L"	Oscillation stop	High impedance: Disable		
#2	GND	GND terminal				
#3	OUT	Output terminal				
#4	V_{CC}	V _{CC} terminal				

Marking



Page 24 / 34 Spec No : SGxxxxCAN_E_Ver3.0

(9-4) SG5032CAN
5.0±0.2

#4

#3

1.6

+ 1.6

- 2.54

- 2.54

2.54 #3 C0.47 0.63 1.2 1.34 #1 0.8

Terminal coating: Au plating

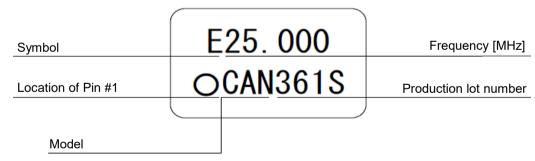
For stable operation, it is recommended that 0.01 μ F to 0.1 μ F bypass capacitors should be connected between V_{CC} and GND and placed as close to the V_{CC} pin as possible.

Reference Weight Typ.: 52 mg

Terminal Assignment

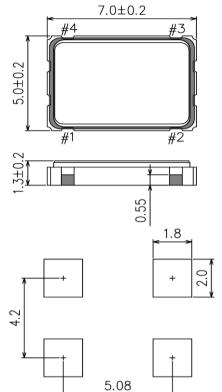
orthinal 7 teolgriment						
Pin #	Connection	Function				
		ST terminal	ST terminal			
#1	#1 ST	ST function	Osc. Circuit	Output		
#1		"H" or OPEN	Oscillation	Specified frequency: Enable		
		"L"	Oscillation stop	High impedance: Disable		
#2	GND	GND terminal				
#3	OUT	Output terminal				
#4	V _{cc}	V _{CC} terminal				

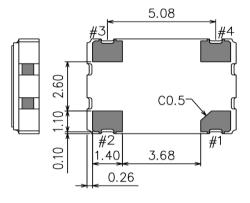
Marking



Page 25 / 34 Spec No : SGxxxxCAN_E_Ver3.0

(9-5) SG7050CAN





Terminal coating: Au plating

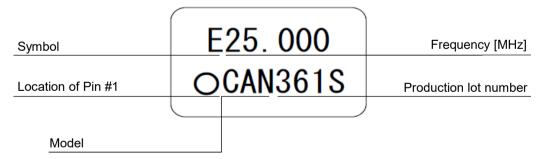
For stable operation, it is recommended that 0.01 μ F to 0.1 μ F bypass capacitors should be connected between V_{CC} and GND and placed as close to the V_{CC} pin as possible.

Reference Weight Typ.: 147 mg

Terminal Assignment

Pin #	Connection	Function			
#1	ST	ST terminal			
		ST function	Osc. Circuit	Output	
		"H" or OPEN	Oscillation	Specified frequency: Enable	
		"L"	Oscillation stop	High impedance: Disable	
#2	GND	GND terminal			
#3	OUT	Output terminal			
#4	V_{CC}	V _{CC} terminal			

Marking

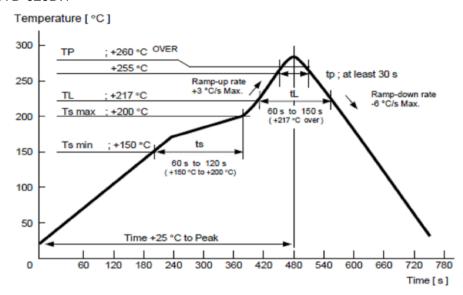


Page 26 / 34 Spec No : SGxxxxCAN_E_Ver3.0

[10] Moisture Sensitivity Level

Parameter	Specification	Conditions
MSL	LEVEL 1	IPC/JEDEC J-STD-020D.1

[11] Reflow Profiles IPC/JEDEC J-STD-020D.1



Page 27 / 34 Spec No : SGxxxxCAN_E_Ver3.0

[12] Packing Information

(12-1) SG2016CAN

(1) Packing Quantity

The last two digits of the Product Number (X1G004801xxxxxxx) are a code that defines the packing quantity. The standard is "00" for a 3 000 pcs/Reel.

(2) Taping Specification

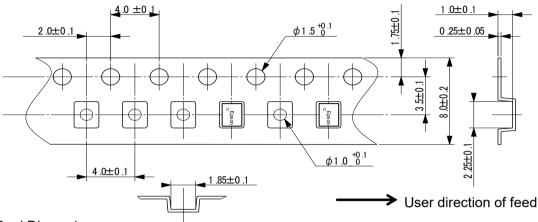
Subject to EIA-481, IEC-60286 and JIS C0806

1) Tape Dimensions

Carrier Tape Material: PS (Polystyrene)

Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene)

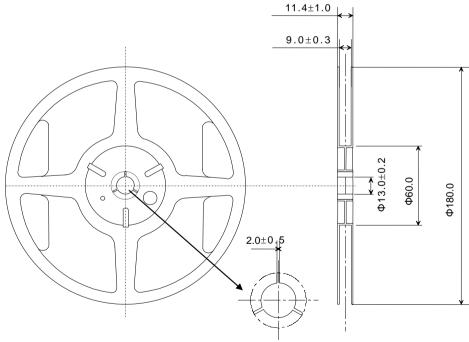
Units: mm



2) Reel Dimensions

Center Material: PS (Polystyrene) Reel Material: PS (Polystyrene)

Units: mm



3) Storage Environment

We recommend to keep less than +30 °C and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

Page 28 / 34 Spec No : SGxxxxCAN_E_Ver3.0

(12-2) SG-210STF

(1) Packing Quantity

The last two digits of the Product Number (X1G004171xxxxxxx) are a code that defines the packing quantity. The standard is "00" for a 3 000 pcs/Reel.

(2) Taping Specification

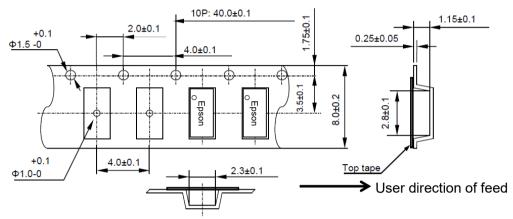
Subject to EIA-481, IEC-60286 and JIS C0806

1) Tape Dimensions

Carrier Tape Material: PS (Polystyrene)

Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene)

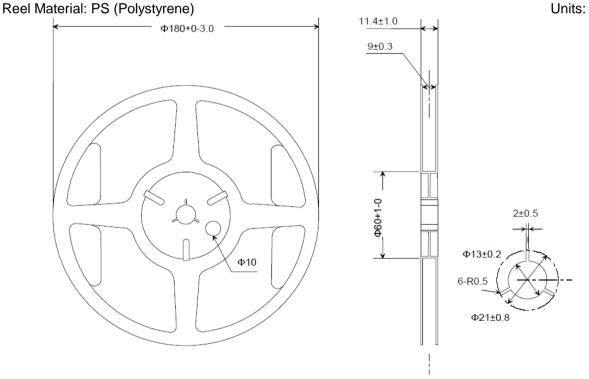
Units: mm



2) Reel Dimensions

Center Material: PS (Polystyrene)

Units: mm



3) Storage Environment

We recommend to keep less than +30 °C and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

> Spec No: SGxxxxCAN_E_Ver3.0 Page 29 / 34

(12-3) SG3225CAN

(1) Packing Quantity

The last two digits of the Product Number (X1G005961xxxxxxx) are a code that defines the packing quantity. The standard is "15" for a 2 000 pcs/Reel.

(2) Taping Specification

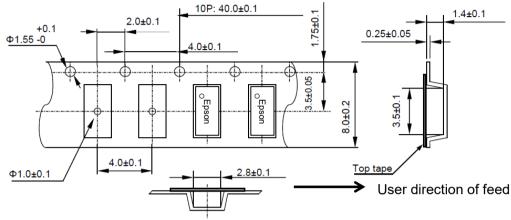
Subject to EIA-481, IEC-60286 and JIS C0806

1) Tape Dimensions

Carrier Tape Material: PS (Polystyrene)

Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene)

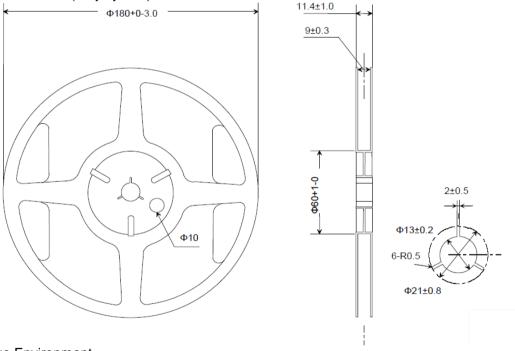
Units: mm



2) Reel Dimensions

Center Material: PS (Polystyrene) Reel Material: PS (Polystyrene)

Units: mm



3) Storage Environment

We recommend to keep less than +30 °C and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

Page 30 / 34 Spec No : SGxxxxCAN_E_Ver3.0

(12-4) SG5032CAN

(1) Packing Quantity

The last two digits of the Product Number (X1G004451xxxxxxx) are a code that defines the packing quantity. The standard is "00" for a 1 000 pcs/Reel.

(2) Taping Specification

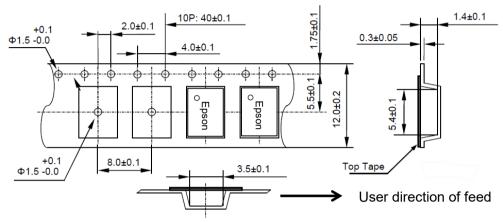
Subject to EIA-481, IEC-60286 and JIS C0806

1) Tape Dimensions

Carrier Tape Material: PS (Polystyrene)

Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene)

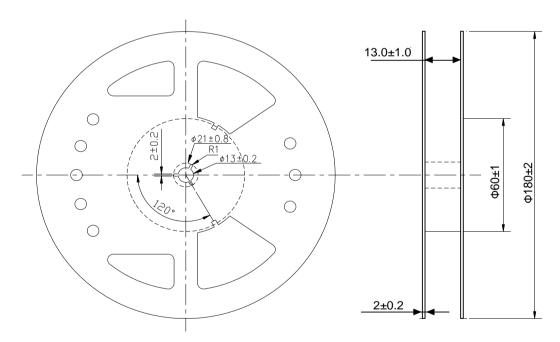
Units: mm



2) Reel Dimensions

Center Material: PS (Polystyrene) Reel Material: PS (Polystyrene)

Units: mm



3) Storage Environment

We recommend to keep less than +30 °C and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

Page 31 / 34 Spec No : SGxxxxCAN_E_Ver3.0

(12-5) SG7050CAN

(1) Packing Quantity

The last two digits of the Product Number (X1G004481xxxxxxx) are a code that defines the packing quantity. The standard is "00" for a 1 000 pcs/Reel.

(2) Taping Specification

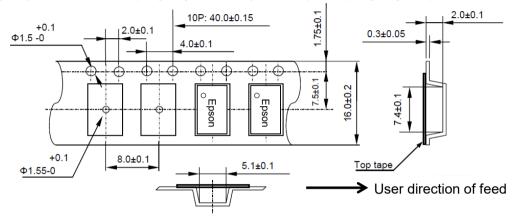
Subject to EIA-481, IEC-60286 and JIS C0806

1) Tape Dimensions

Carrier Tape Material: PS (Polystyrene)

Top Tape Material: PET (Polyethylene Terephthalate) +PE (Polyethylene)

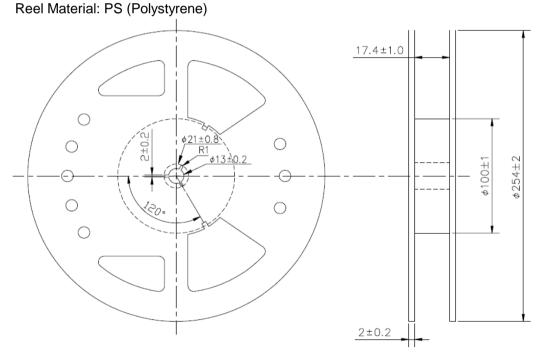
Units: mm



2) Reel Dimensions

Center Material: PS (Polystyrene)

Units: mm



3) Storage Environment

We recommend to keep less than +30 °C and 85 %RH of humidity in a packed condition, and to use it less than 6 months after delivery.

Page 32 / 34 Spec No : SGxxxxCAN_E_Ver3.0

[13] Handling Precautions

Prior to using this product, please carefully read the section entitled "Precautions" on our Web site (https://www5.epsondevice.com/en/information/#precaution) for instructions on how to handle and use the product properly to ensure optimal performance of the product in your equipment.

Before using the product under any conditions other than those specified therein.

please consult with us to verify and confirm that the performance of the product will not be negatively affected by use under such conditions.

In addition to the foregoing precautions, in order to avoid the deteriorating performance of the product, we strongly recommend that you DO NOT use the product under ANY of the following conditions:

- (1) Do not expose this product to excessive mechanical shock or vibration.
- (2) This product can be damaged by mechanical shock during the soldering process depending on the equipment used, process conditions, and any impact forces experienced. Always follow appropriate procedures, particularly when changing the assembly process in any way and be sure to follow applicable process qualification standards before starting production.
- (3) These devices are sensitive to ESD, use appropriate precautions during handling, assembly, test, shipment, and installation.
- (4) The use of ultrasonic technology for cleaning, bonding, etc. can damage the Xtal unit inside this product. Please carefully check for this consideration before using ultrasonic equipment for volume production with this product.
- (5) Noise and ripple on the power supply may have undesirable affects on operation and cause degradation of phase noise characteristics. Evaluate the operation of this device with appropriate power supplies carefully before use.
- (6) When applying power, ensure that the supply voltage increases monotonically for proper operation. On power down, do not reapply power until the supplies, bypass capacitors, and any bulk capacitors are completely discharged since that may cause the unit to malfunction.
- (7) Aging specifications are estimated from environmental reliability tests and expected frequency variation over time. They do not provide a guarantee of aging over the product lifecycle.
- (8) The metal cap on top of the device is directly connected to the GND terminal. Take necessary precautions to prevent any conductor not at ground potential from contacting the cap as that could cause a short circuit to GND.
- (9) To avoid any issues due to interference of other signal lines, please take care not to place signal lines near the product as this may have an adverse affect on the performance of the product.
- (10) A bypass capacitor of the recommended value(s) must be connected between the V_{CC} and GND terminals of the product. Whenever possible, mount the capacitor(s) on the same side of the PCB and as close to the product as possible to keep the routing traces short.
- (11) Power supply connections to V_{CC} and GND pins should be routed as thick as possible while keeping the high frequency impedance low in order to get the best performance.
- (12) The use of a filter or similar element in series with the power supply connections to protect from electromagnetic radiation noise may increase the high frequency impedance of the power supply line and may cause the oscillator to not operate properly. Please verify the design to ensure sufficient operational margin prior to use.
- (13) Keep PCB routing from the output terminal(s) to the load as short as possible for best performance.
- (14) The Enable (\$\overline{ST}\$) input terminal is high impedance and so susceptible to noise. Connect it to a low impedance source when used and when not used it is recommended to connect it to Vcc for active high inputs and GND for active low inputs.
- (15) Do not short the output to GND as that will damage the product. Always use with an appropriate load resistor connected.
- (16) This product should be reflowed no more than 3 times.

 If rework is needed after reflow, please correct it with a soldering iron with the tip set for a temperature of +350 °C or less and only contact each terminal once and for no more than 5 seconds.

 If this product is mounted on the bottom of the board during a reflow please check that it soldered down properly afterwards.

wanabinty of mounting t	Conditions
Reflow on the board	Avallable
Reflow under the board	The parts may fall. Please judge whether it is possible to implement.
Soldering pot/bath (Dip soldering system, Flow soldering system)	Not Avallable
Soldering iron	Avallable

- (17) Product failures during the warranty period only apply when the product is used according to the recommended operating conditions described in the specifications. Products that have been opened for analysis or damaged will not be covered. It is recommended to store and use in normal temperature and humidity environments described in the specifications to ensure frequency accuracy and prevent moisture condensation. If the product is stored for more than one year, please confirm the pin solderability prior to use.
- (18) If the oscillation circuit is exposed to condensation, the frequency may change or oscillation may stop. Do not use in any conditions where condensation occurs.
- (19) Do not store or use the product in an environment where it can be exposed to chemical substances that are corrosive to metal or plastics such as salt water, organic solvents, chemical gasses, etc. Do not use the product when it is exposed to sunlight, dust, corrosive gasses, or other materials for long periods of time.
- (20) When using water-soluble solder flux make sure to completely remove the flux residue after soldering.

 Pay particular attention when the residues contain active halogens which will negatively affect the product and its performance.
- (21) Terminals on the side of the product are internally connected to the IC, be careful not to cause short-circuits or reduce the insulation resistance of them in any way.
- (22) Should any customer use the product in any manner contrary to the precautions and/or advice herein, such use shall be done at the customer's own risk.

Page 33 / 34 Spec No : SGxxxxCAN_E_Ver3.0

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification. ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation

WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major manufacturers as standard.

IATF 16949 is the international standard that added the sectorspecific supplemental requirements for automotive industry based on ISO9001.

Explanation of marks used in this datasheet



●Pb free.



Complies with EU RoHS directive.

*About the products without the Pb-free mark.

Contains Pb in products exempted by EU RoHS directive

(Contains Pb in sealing glass, high melting temperature type solder or other)

NOTICE: PLEASE READ CAREFULLY BELOW BEFORE THE USE OF THIS DOCUMENT

- 1. The content of this document is subject to change without notice. Before purchasing or using Epson products, please contact with sales representative of Seiko Epson Corporation ("Epson") for the latest information and be always sure to check the latest information published on Epson's official web sites and resources.
- 2. This document may not be copied, reproduced, or used for any other purposes, in whole or in part, without Epson's prior consent.
- 3. Information provided in this document including, but not limited to application circuits, programs and usage, is for reference purpose only. Epson makes no guarantees against any infringements or damages to any third parties' intellectual property rights or any other rights resulting from the information. This document does not grant you any licenses, any intellectual property rights or any other rights with respect to Epson products owned by Epson or any third parties.
- 4. Epson has prepared this document carefully to be accurate and dependable, but Epson does not guarantee that the information is always accurate and complete. Epson assumes no responsibility for any damages you incurred due to any misinformation in this document.
- 5. No dismantling, analysis, reverse engineering, modification, alteration, adaptation, reproduction, etc., of Epson products is allowed. regarding Epson products (including, but not limited to this document, specifications, data sheets, manuals, and Epson's web site). Using technical contents such as product data, graphic and chart, and technical information, including programs, algorithms and application circuit examples under this document, you shall evaluate your products thoroughly both in stand-alone basis and within your overall systems. You shall be solely responsible for deciding whether to adopt/use Epson products with your products.
- 6. Epson assumes no responsibility for any damages (whether direct or indirect) caused by or in relation with your non-compliance with the terms and conditions in this document or for any damages (whether direct or indirect) incurred by any third party that you give, transfer or assign Epson products.
- For more details or other concerns about this document, please contact our sales representative.
- 8. Company names and product names listed in this document are trademarks or registered trademarks of their respective companies.
- Disclaimer
- 1. Epson products are designed for use in general electronic equipment applications that do not require extremely high reliability or safety.
- 2. Epson does not represent or warrant that its products will not cause a failure for any particular application, except for cases where the failure is a direct result caused by defects in materials and workmanship of this product.
 If a product fails due to defects in materials and workmanship, to the maximum extent permitted by law, we will, at our sole discretion, refund or replace the affected product.
- 3. When products for used directly or indirectly in certain devices or applications (ex. Nuclear power, aerospace, infrastructure facilities, medical equipment, etc.) which are connected to or affect safety of human life or property, Customer is solely responsible for determining Customer shall implement necessary and proper safety design and measures (including redundant design, malfunction prevention design, etc.) to ensure reliability and safety before using the products in/with customer's Equipment.
- 4. No dismantling, analysis, reverse engineering, modification, alteration, adaptation, reproduction, etc., of Epson products is allowed. Furthermore, any defects caused by this are not covered by the warranty.

©Seiko Epson Corporation 2025

Page 34 / 34 Spec No : SGxxxxCAN_E_Ver3.0